

# 1.8 V/2.5 V CML 12.5 Gbps Programmable Pre-Emphasis Copper/Cable Driver with Selectable Equalizer Receiver Multi-Level Inputs w/ Internal Termination

## NB7VPQ16M

### Description

The NB7VPQ16M is a high performance single channel programmable Pre-Emphasis CML Driver with a selectable Equalizer Receiver that operates up to 14 Gbps typical with a 1.8 V or 2.5 V power supply. When placed in series with a Data/Clock path, the NB7VPQ16M inputs will compensate the degraded signal transmitted across a FR4 PCB backplane or cable interconnect. Therefore, the serial data rate is increased by reducing Inter-Symbol Interference (ISI) caused by losses in copper interconnect or long cables.

The Pre-Emphasis buffer is controlled using a serial bus via the Serial Data In (SDIN) and Serial Clock In (SCLKIN) control inputs and contains circuitry which provides sixteen programmable Pre-Emphasis settings to select the optimal output compensation level.

These selectable output levels will handle various backplane lengths and cable lines. The first four SDIN bits (D3:D0) will digitally select 0 dB through 12 dB typical of de-emphasis (see Table 1).

For cascaded applications, the shifted SDIN and SCLKIN signals are presented at the SDOUT and SCLKOUT pins.

The 5<sup>th</sup>-bit (LSB) of the serial data bits allows for enabling the equalization function of the receiver.

The differential Data / Clock inputs incorporate a pair of internal 50  $\Omega$  termination resistors, in a 100  $\Omega$  center-tapped configuration, via the VT pin and will accept LVPECL, CML or LVDS logic levels. This feature provides transmission line termination on-chip, at the receiver end, eliminating external components.

The NB7VPQ16M is a member of the GigaComm™ Family of high performance Data/Clock products with Pre-Emphasis/Equalization (PEEQ).

### Features

- Maximum Input Data Rate > 12.5 Gbps
- Maximum Input Clock Frequency > 8 GHz
- Drives Up To 18-inches of FR4
- (16) Programmable Output De-emphasis Levels; 0 dB through 12 dB
- 200 ps Typical Propagation Delay
- Differential CML Outputs, 400 mV Peak-to-Peak, Typical (PE = 0 dB)
- Operating Range:  $V_{CC} = 1.71 \text{ V to } 2.625 \text{ V}$ ,  $GND = 0 \text{ V}$
- Internal Output Termination Resistors, 50  $\Omega$
- QFN-16 Package, 3 mm x 3 mm
- $-40^{\circ}\text{C to } +85^{\circ}\text{C}$  Ambient Operating Temperature
- These are Pb-Free Devices



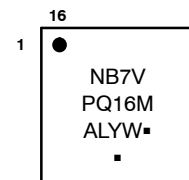
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1  
QFN-16  
MN SUFFIX  
CASE 485G

### MARKING DIAGRAM\*



A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note [AND8002/D](#).

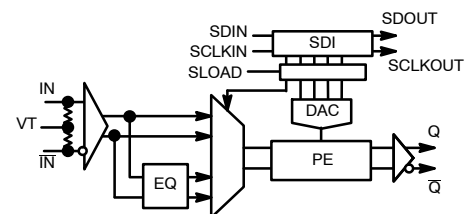


Figure 1. Simplified Logic Diagram

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 15 of this data sheet.

## NB7VPQ16M

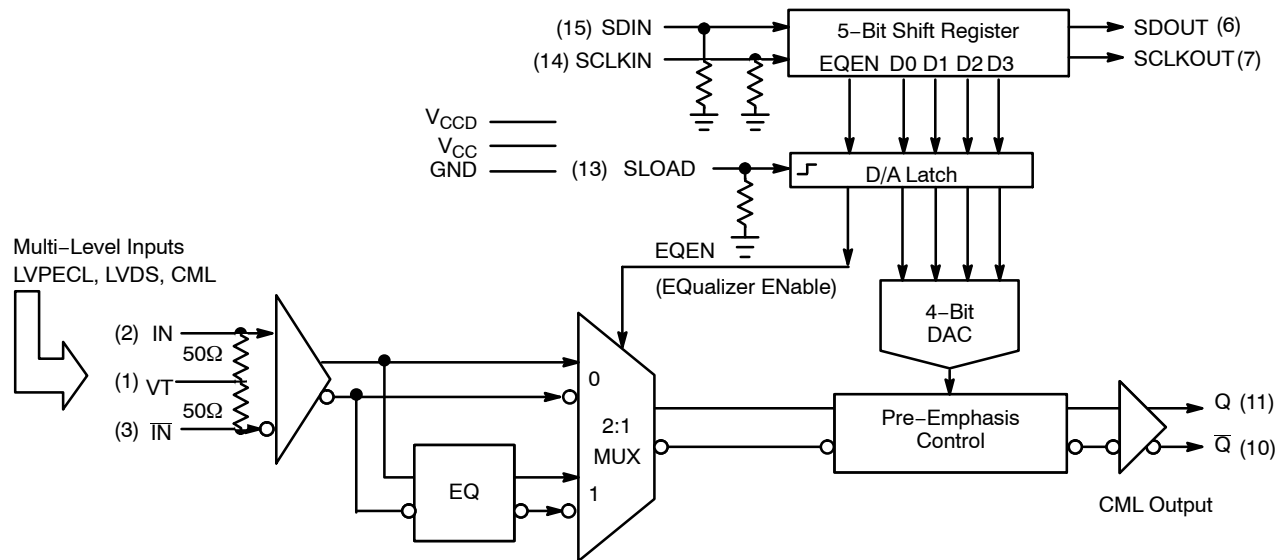
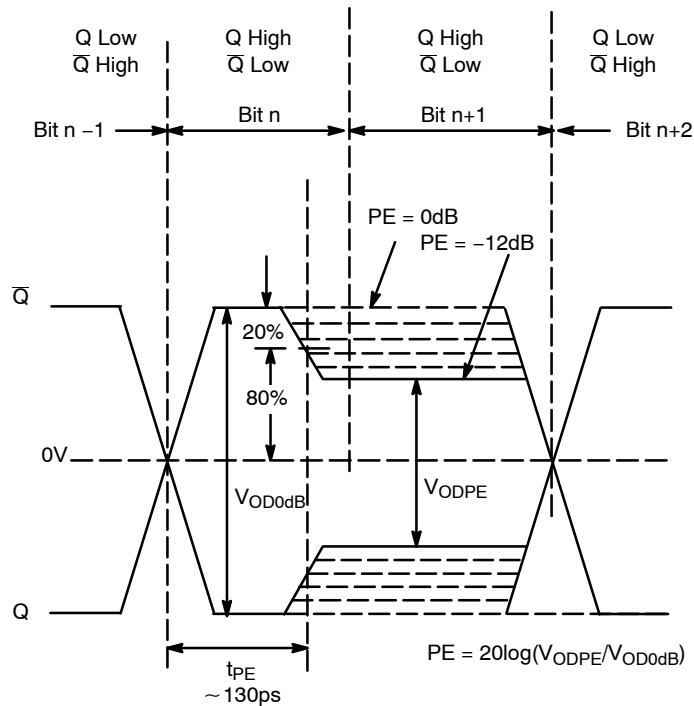


Figure 2. Detailed Block Diagram of NB7VPQ16M



V<sub>OD0dB</sub> – Differential Output Voltage without Pre-Emphasis  
V<sub>ODPE</sub> – Differential Output Voltage with Pre-Emphasis

Figure 3. Illustration of Output Waveform Definition

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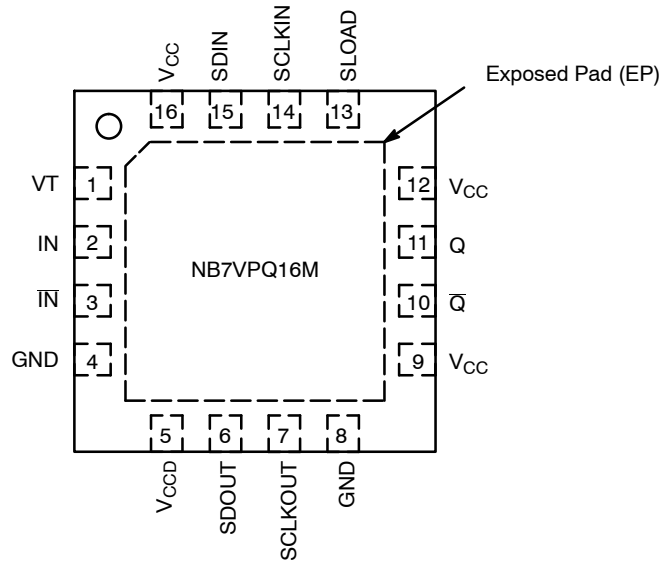
**Table 1. TYPICAL PRE-EMPHASIS CONTROL TABLE, EQ = 0, 25°C, V<sub>CC</sub> = 1.8 V**

Decimal	4-bit PE				PE Output Compensation in dB Approximate @ 1 GHz	V <sub>ODPE</sub> Typ (mV)
	MSB			LSB		
	D3	D2	D1	D0		
00	0	0	0	0	0 dB (Default)	435
01	0	0	0	1	-1.0 dB	390
02	0	0	1	0	-1.5 dB	365
03	0	0	1	1	-2.0 dB	345
04	0	1	0	0	-2.5 dB	325
05	0	1	0	1	-3.0 dB	310
06	0	1	1	0	-3.5 dB	290
07	0	1	1	1	-4.0 dB	275
08	1	0	0	0	-4.5 dB	260
09	1	0	0	1	-5.0 dB	245
10	1	0	1	0	-6.0 dB	220
11	1	0	1	1	-7.0 dB	195
12	1	1	0	0	-8.0 dB	175
13	1	1	0	1	-9.0 dB	155
14	1	1	1	0	-10.0 dB	135
15	1	1	1	1	-12.0 dB	110

**Table 2. EQUALIZER ENABLE FUNCTION**

EQEN	Function
0	IN/ $\overline{\text{IN}}$ Inputs By-pass the Equalizer section
1	Inputs flow through the Equalizer

## NB7VPQ16M



**Figure 4. Pin Configuration (Top View)**

**Table 3. PIN DESCRIPTION**

Pin	Name	I/O	Description
1	VT		Internal 50-Ω Termination Pin for IN and $\overline{\text{IN}}$
2	IN	LVPECL, CML, LVDS Input	Non-inverted Differential Clock/Data Input. (Note 1)
3	$\overline{\text{IN}}$	LVPECL, CML, LVDS Input	Inverted Differential Clock/Data Input. (Note 1)
4	GND	–	Negative Supply Voltage; (Note 2)
5	VCCD	–	Positive Supply Voltage for Serial Bus Logic and 5-Bit DAC; (Note 2)
6	SDOUT	LVC MOS Output	Serial Data Out
7	SCLKOUT	LVC MOS Output	Serial Clock Out
8	GND	–	Negative Supply Voltage; (Note 2)
9	VCC	–	Positive Supply Voltage for the analog circuitry and CML Output buffer; (Note 2)
10	$\overline{\text{Q}}$	CML	Inverted Differential Output. (Note 1)
11	Q	CML	Non-inverted Differential Output. (Note 1)
12	VCC	–	Positive Supply Voltage for the analog circuitry and CML Output buffer; (Note 2)
13	SLOAD	LVC MOS Input	When the SLOAD pin is LOW or left open (has internal pulldown resistor), the output of the shift register will input the 4-bit DAC and set the EQEN bit. When HIGH, the input to the 4-bit DAC is locked to the state prior to when SLOAD went HIGH.
14	SCLKIN	LVC MOS Input	Serial Clock In; pin will default LOW when left open (has internal pulldown resistor)
15	SDIN	LVC MOS Input	Serial Data In; pin will default LOW when left open (has internal pulldown resistor)
16	VCC	–	Positive Supply Voltage for the analog circuitry and CML Output buffer; (Note 2)
	EP		The Exposed Pad (EP) on the QFN-16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is also electrically connected to the die, and must be electrically and thermally connected to GND on the PC board.

1. In the differential configuration when the input termination pin ( $\text{V}_\text{T}$ ) is connected to a common termination voltage or left open, and if no input signal is applied on IN/ $\overline{\text{IN}}$  input, then the device will be susceptible to self-oscillation. Q/ $\overline{\text{Q}}$  outputs have internal 50 Ω source termination resistor.
2. All  $\text{V}_{\text{CC}}$ ,  $\text{V}_{\text{CCD}}$  and GND pins must be externally connected to a power supply voltage to guarantee proper device operation.

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**Table 4. ATTRIBUTES**

Characteristics	Value
ESD Protection Human Body Model Machine Model	> 4 kV > 200 V
Internal Input Pulldown Resistor	75 k $\Omega$
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 3)	Level 1
Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in
Transistor Count	416
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	

3. For additional information, see Application Note [AND8003/D](#)

**Table 5. MAXIMUM RATINGS**

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
$V_{CC}, V_{CCD}$	Positive Power Supply	GND = 0 V		3.0	V
$V_{IN}$	Positive Input Voltage	GND = 0 V		-0.5 to $V_{CC} + 0.5$	V
$V_{INPP}$	Differential Input Voltage $ I_N - \bar{I}_N $			1.89	V
$I_{out}$	Output Current	Continuous Surge		34 40	mA
$I_{IN}$	Input Current Through $R_T$ (50 $\Omega$ Resistor)			$\pm 40$	mA
$T_A$	Operating Temperature Range			-40 to +85	$^{\circ}\text{C}$
$T_{stg}$	Storage Temperature Range			-65 to +150	$^{\circ}\text{C}$
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient) (Note 4) TGSD 51-6 (2S2P Multilayer Test Board) with Filled Thermal Vias	0 lfpm 500 lfpm	QFN-16 QFN-16	42 35	$^{\circ}\text{C}/\text{W}$
$\theta_{JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	QFN-16	4	$^{\circ}\text{C}/\text{W}$
$T_{sol}$	Wave Solder Pb-Free			265	$^{\circ}\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

4. JEDEC standard multilayer board – 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

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**Table 6. DC CHARACTERISTICS POSITIVE CML OUTPUT**  $V_{CC} = V_{CCD} = 1.71 \text{ V to } 2.625 \text{ V}$ ;  $GND = 0 \text{ V}$ ;  $T_A = -40^\circ\text{C to } 85^\circ\text{C}$  (Note 5)

Symbol	Characteristic	Min	Typ	Max	Unit
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## POWER SUPPLY CURRENT

$I_{CC}$	Power Supply Current, (Inputs and Outputs Open) PE = 0dB	$V_{CC} = 2.5 \text{ V}$ $V_{CC} = 1.8 \text{ V}$		95 80	120 100	mA
$I_{CCD}$	Power Supply Current for Serial Bus and DAC (Inputs and Outputs Open)	PE = 0000 = 0dB PE = 1111 = Max		0 10	20	mA

## CML OUTPUTS PE = 0dB (Note 6, Figure 22)

$V_{OH}$	Output HIGH Voltage	$V_{CC} = 2.5 \text{ V}$ $V_{CC} = 1.8 \text{ V}$	$V_{CC} - 30$ 2470 1770	$V_{CC} - 10$ 2490 1790	$V_{CC}$ 2500 1800	mV
$V_{OL}$	Output LOW Voltage	$V_{CC} = 2.5 \text{ V}$ $V_{CC} = 1.8 \text{ V}$	$V_{CC} - 600$ 1900 $V_{CC} - 550$ 1250	$V_{CC} - 500$ 2000 $V_{CC} - 450$ 1350	$V_{CC} - 400$ 2100 $V_{CC} - 350$ 1450	mV

## DATA/CLOCK INPUTS (IN, $\overline{IN}$ ) (Note 7) (Figure 6)

$V_{IHD}$	Differential Input HIGH Voltage	1100		$V_{CC}$	mV
$V_{ILD}$	Differential Input LOW Voltage	GND		$V_{CC} - 100$	mV
$V_{ID}$	Differential Input Voltage ( $V_{IHD} - V_{ILD}$ )	100		1200	mV
$I_{IH}$	Input HIGH Current	-150	20	150	$\mu\text{A}$
$I_{IL}$	Input LOW Current	-150	5	150	$\mu\text{A}$

## CONTROL INPUTS (SDIN, SCLKIN, SLOAD)

$V_{IH}$	Input HIGH Voltage for Control Pins	$V_{CCD} \times 0.65$		$V_{CCD}$	mV
$V_{IL}$	Input LOW Voltage for Control Pins	GND		$V_{CCD} \times 0.35$	mV
$I_{IH}$	Input HIGH Current	-150	20	150	$\mu\text{A}$
$I_{IL}$	Input LOW Current	-150	5	150	$\mu\text{A}$

## CONTROL OUTPUTS (SDOUT, SCLKOUT)

$V_{OH}$	Output HIGH Voltage	$V_{CC} - 200$		$V_{CC}$	mV
$V_{OL}$	Output LOW Voltage	GND		200	mV

## TERMINATION RESISTORS

$R_{TIN}$	Internal Input Termination Resistor	45	50	55	$\Omega$
$R_{TOUT}$	Internal Output Termination Resistor	45	50	55	$\Omega$

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm.

- Input and output parameters vary 1:1 with  $V_{CC}$ .
- CML outputs loaded with  $50 \Omega$  to  $V_{CC}$  for proper operation.
- $V_{IHD}$ ,  $V_{ILD}$ ,  $V_{ID}$  and  $V_{CMR}$  parameters must be complied with simultaneously.

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**Table 7. AC CHARACTERISTICS**  $V_{CC} = V_{CCD} = 1.71 \text{ V to } 2.625 \text{ V}$ ;  $GND = 0 \text{ V}$ ;  $T_A = -40^\circ\text{C to } 85^\circ\text{C}$  (Note 8)

Symbol	Characteristic	Min	Typ	Max	Unit
$f_{\text{DATAMAX}}$	Maximum Input Data Rate	12.5	14		Gbps
$f_{\text{MAX}}$	Maximum Input Clock Frequency (Note 9) $V_{\text{OUTTP}} \geq 200 \text{ mV}$	8			GHz
$f_{\text{SCLKIN}}$	Serial Clock Input Frequency			20	MHz
$V_{\text{OD0dB}}$	Output Voltage Amplitude (see Table 1) (@ $V_{\text{INPPmin}}$ ) (See Figure 3, Note 9) $f_{\text{in}} \leq 6.0 \text{ GHz}$ $f_{\text{in}} \leq 8.0 \text{ GHz}$	300 200	400 300		mV
$t_{\text{PE}}$	Pre-Emphasis Width, tested at $-12\text{dB}$ Pre-Emphasis		130		ps
$V_{\text{CMR}}$	Input Common Mode Range (Differential Configuration, Note 10) (Figure 8)	1050		$V_{\text{CC}}$	mV
$t_{\text{PLH}}$ , $t_{\text{PHL}}$	Propagation Delay to Differential Outputs, 1 GHz, measured at differential cross-point $\text{IN}/\overline{\text{IN}}$ to $\text{Q}/\overline{\text{Q}}$ $\text{SCLKIN}$ to $\text{SCLKOUT}$	150	200 5	250 10	ps ns
$t_{\text{DC}}$	Output Clock Duty Cycle (Reference Duty Cycle = 50%) $f_{\text{in}} \leq 5.0 \text{ GHz}$	45	50	55	%
$t_{\text{s1}}$ $t_{\text{s2}}$ $t_{\text{s3}}$	Setup Time @ 50 MHz (Figures 9 and 10) $\text{SDIN}$ to $\text{SCLKIN}$ $\text{SCLKIN}$ to $\text{SLOAD}$ $\text{SLOAD}$ to $\text{IN}/\overline{\text{IN}}$	5 5 10			ns
$t_{\text{h1}}$ $t_{\text{h2}}$ $t_{\text{h3}}$	Hold Time @ 50 MHz (Figures 9 and 10) $\text{SDIN}$ to $\text{SCLKIN}$ $\text{SCLKIN}$ to $\text{SLOAD}$	1 2			ns
$t_{\text{PW\_SLOAD}}$	$\text{SLOAD}$ Minimum Pulse Width (Figure 10)	6			ns
$t_{\text{JITTER}}$	RJ – Output Random Jitter (Note 11) $f_{\text{in}} \leq 8.0 \text{ GHz}$ DJ – Residual Output Deterministic Jitter (Note 12) (EQ = 0, PE = 0 dB) $\text{FR4} \leq 3''$ , $f \leq 12.5 \text{ Gbps}$ (Figures 15 and 16) $\text{FR4} = 12''$ , $f \leq 6.5 \text{ Gbps}$		0.1	0.8 10 10	ps rms ps pk-pk
$V_{\text{INPP}}$	Input Voltage Swing (Differential Configuration) (Note 9)	100		1200	mV
$t_r$ , $t_f$	Output Rise/Fall Times @ 1 GHz (20% – 80%), Q, $\overline{\text{Q}}$		35	50	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm.

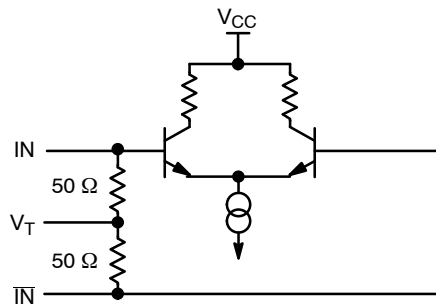
8. Measured using a 400 mV source, 50% duty cycle clock source. All output loading with external  $50 \Omega$  to  $V_{\text{CC}}$ . Input edge rates 40 ps. (20% – 80%); PE = 0 dB, EQEN = 0

9. Input / Output voltage swing is a single-ended measurement operating in differential mode.

10.  $V_{\text{CMR}}$  min varies 1:1 with GND,  $V_{\text{CMR}}$  max varies 1:1 with  $V_{\text{CC}}$ . The  $V_{\text{CMR}}$  range is referenced to the most positive side of the differential input signal.

11. Additive RMS jitter with 50% duty cycle Clock signal.

12. Peak-to-Peak jitter with input NRZ data at PRBS23.



**Figure 5. Input Structure**

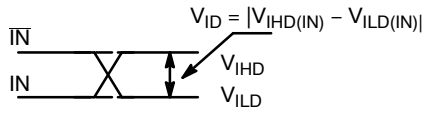


Figure 6. Differential Inputs Driven Differentially

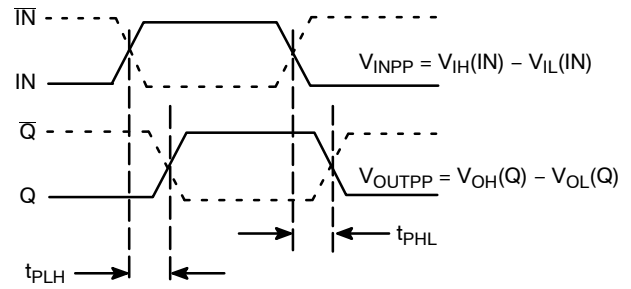


Figure 7. AC Reference Measurement

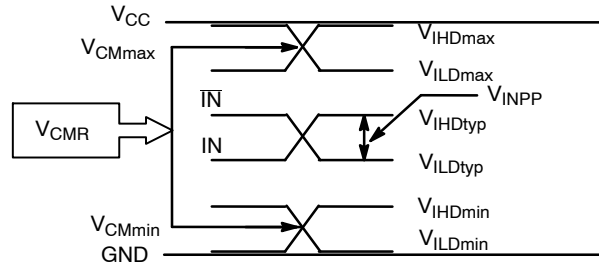


Figure 8.  $V_{CMR}$  Diagram

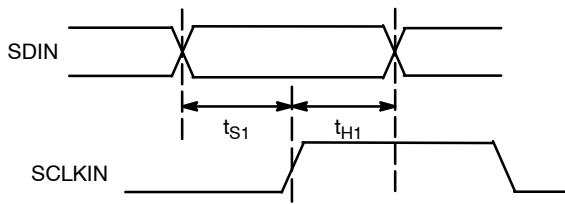


Figure 9. SDIN/SCLKIN Setup and Hold Time

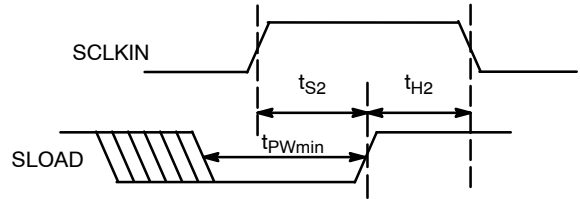


Figure 10. SLOAD Set-Up and Hold and  $t_{PWmin}$



## APPLICATION INFORMATION

### Data Inputs

The differential  $\text{IN}/\overline{\text{IN}}$  inputs of the NB7VPQ16M can accept LVPECL, CML, and LVDS signal levels. The limitations for a differential input signal (LVDS, LVPECL, or CML) is a minimum input swing of 100 mV (single-ended measurement). Within this condition, the input HIGH voltage,  $V_{\text{IH}}$ , can range from  $V_{\text{CC}}$  down to 1.1 V. Example interfaces are illustrated in Figure 17.

### Serial Data Interface

The Serial Data Interface (SDI) logic is implemented with a 5-bit shift register scheme. The register shifts once per rising edge of the SCLKIN input. The serial data input SDIN must meet setup and hold timing as specified in the AC table. The configuration latches will capture the value of the shift register on the Low-to-High edge of the SLOAD input. The most significant bit (MSB) is loaded first. See the programming timing diagram for more information.

### SDIN / SCLKIN

SDIN is the Serial Data input pin; SCLKIN is the Serial Clock input pin.

### SLOAD

The SLOAD pin performs the DAC latch function. When LOW or left open, the DAC latch will pass the shift register outputs to the input of the DAC and the Equalizer ENable bit (EQEN). On the Low-to-HIGH transition of SLOAD, the input to the 4-bit DAC is locked to the state prior to when SLOAD went HIGH, and will set the Equalizer ENable bit. The DAC does not get programmed until SLOAD goes HIGH. The SLOAD pin must remain in a HIGH state to maintain the DAC Pre-Emphasis and the EQEN settings. A LOW or open state resets the DAC to 0 dB Pre-Emphasis setting and disables the EQEN bit, regardless of SDIN and SCLKIN values. The SLOAD function is asynchronous.

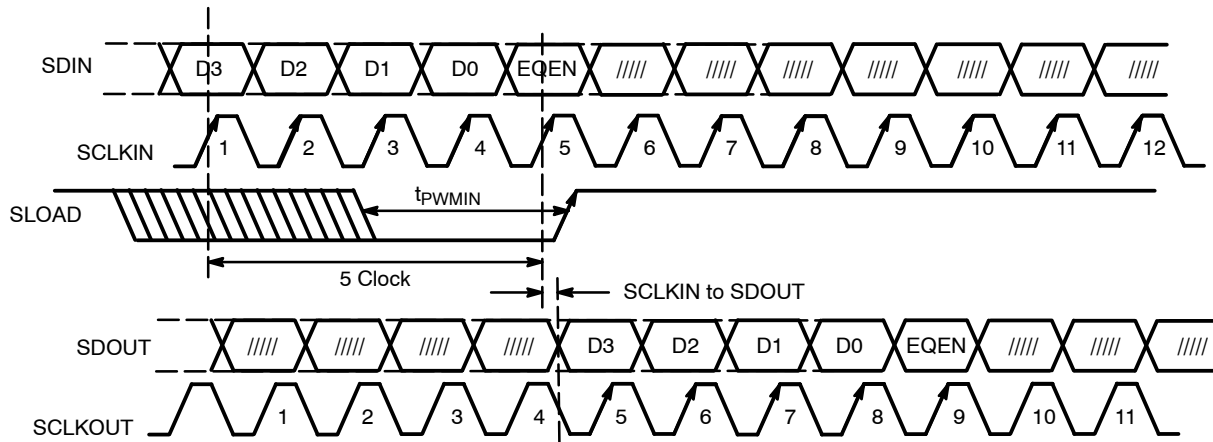


Figure 11. Timing Diagram for Single Channel

### Pre-Emphasis Selection

The Pre-Emphasis buffer is controlled using a serial bus via the SDIN (Serial Data In) and SCLKIN (Serial Clock In) control inputs and contains circuitry which provides sixteen programmable pre-emphasis levels to control the output compensation. The 4-bits (D3:D0) digitally select 0 dB through 12 dB of Pre-Emphasis compensation (see Table 1). The default state at start-up is PE = 0 dB.

### Equalization ENable (EQEN)

The Equalizer ENable (EQEN) allows for enabling the Equalizer function. The control of the Equalizer function is realized by setting the 5th bit, EQEN, of the 5-bit serial data. When EQEN is set Low (or open), the  $\text{IN}/\overline{\text{IN}}$  inputs bypass the Equalizer. When EQEN is set High, the  $\text{IN}/\overline{\text{IN}}$  inputs flow through the Equalizer. The default state at start-up is EQEN = LOW.

### Q/ $\overline{\text{Q}}$ Outputs

The differential outputs of the NB7VPQ16M, Q and  $\overline{\text{Q}}$ , utilize Common Mode Logic (CML) architecture. The outputs are designed to drive differential transmission lines with nominal 50  $\Omega$  characteristic impedance. External termination with a 50  $\Omega$  resistor to  $V_{\text{CC}}$  is recommended. See Figures 22 and 23 for output termination scheme. Alternatively, 100  $\Omega$  line-to-line termination is also acceptable.

### Power Supply Bypass Information

A clean power supply will optimize the performance of the NB7VPQ16M. The device provides separate  $V_{\text{CCD}}$  and  $V_{\text{CC}}$  power supply pins for the digital circuitry and CML outputs. Placing a 0.01  $\mu\text{F}$  to 0.1  $\mu\text{F}$  bypass capacitor on each  $V_{\text{CC}}$  and  $V_{\text{CCD}}$  Pin to ground will help ensure a noise free power supply. The purpose of this design technique is to isolate the CMOS digital switching noise from the high speed input/output path.

## CASCADE APPLICATION

### SDOUT/SCLKOUT

SDOUT is the Serial Data output pin; SCLKOUT is the Serial Clock output pin. These pins are the outputs of the 5-bit SDI shift register and will produce the SDIN/SCLKIN

signals after five serial clock cycles, see Figure 12. The purpose of SDOUT and SCLKOUT is for use in cascade applications, described below.

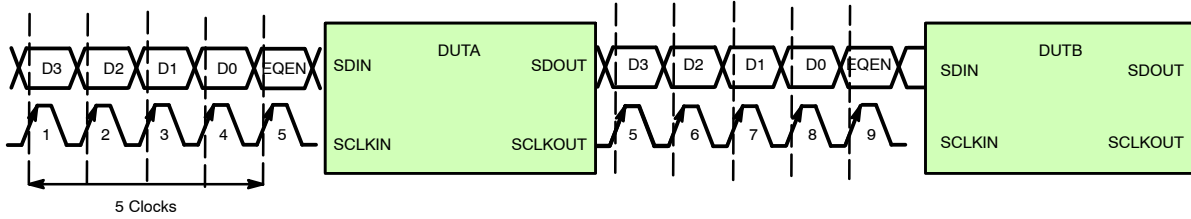


Figure 12. Simplified Cascaded Serial Data/Clock Timing Diagram

### Cascaded Applications

The NB7VPQ16M can be cascaded with multiple NB7VPQ16Ms in series for various Equalizer/Pre-Emphasis applications, as shown in Figure 13.

Serial Data In, SDINA, is clocked with SCLKINA into the cascaded chain of the Pre-Emphasis and equalizer shift registers, (DUTA, DUTB and DUTC), 5-bits per register. Upon the rising edge of the 5<sup>th</sup> clock of SCLKINA, the first valid data bit (D3) and 5<sup>th</sup> clock will exit DUTA from

SDOUTA and SCLKOUTA and will be present at SDINB and SCLKINB of DUTB and so on.

When SLOAD is brought LOW, the PE shift registers of all devices are enabled and data is written into the NB7VPQ16Ms with the contents of the PE shift registers. When the data transfer is complete, SLOAD is brought HIGH and all NB7VPQ16Ms are updated simultaneously. After the PE control bits are clocked into their appropriate registers, the Low-to-High transition of SLOAD will latch the data bits for the Pre-Emphasis DACs.

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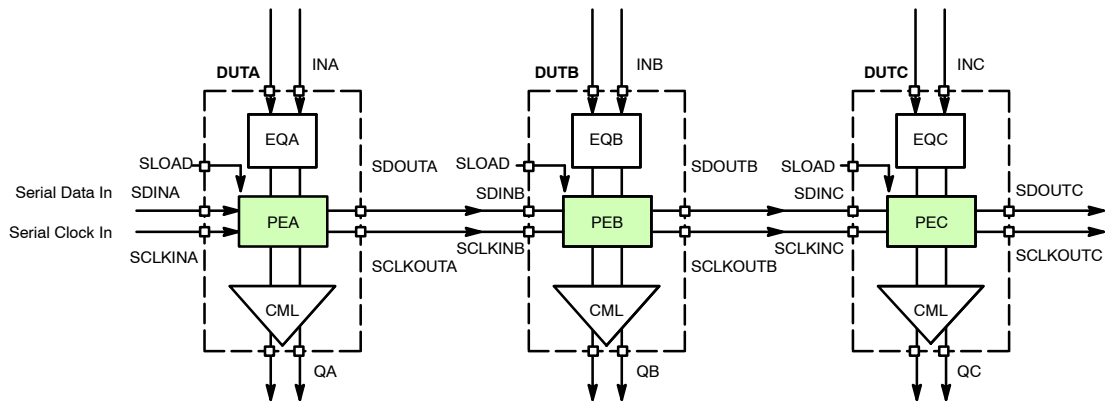


Figure 13. Simplified Cascaded Logic Diagram

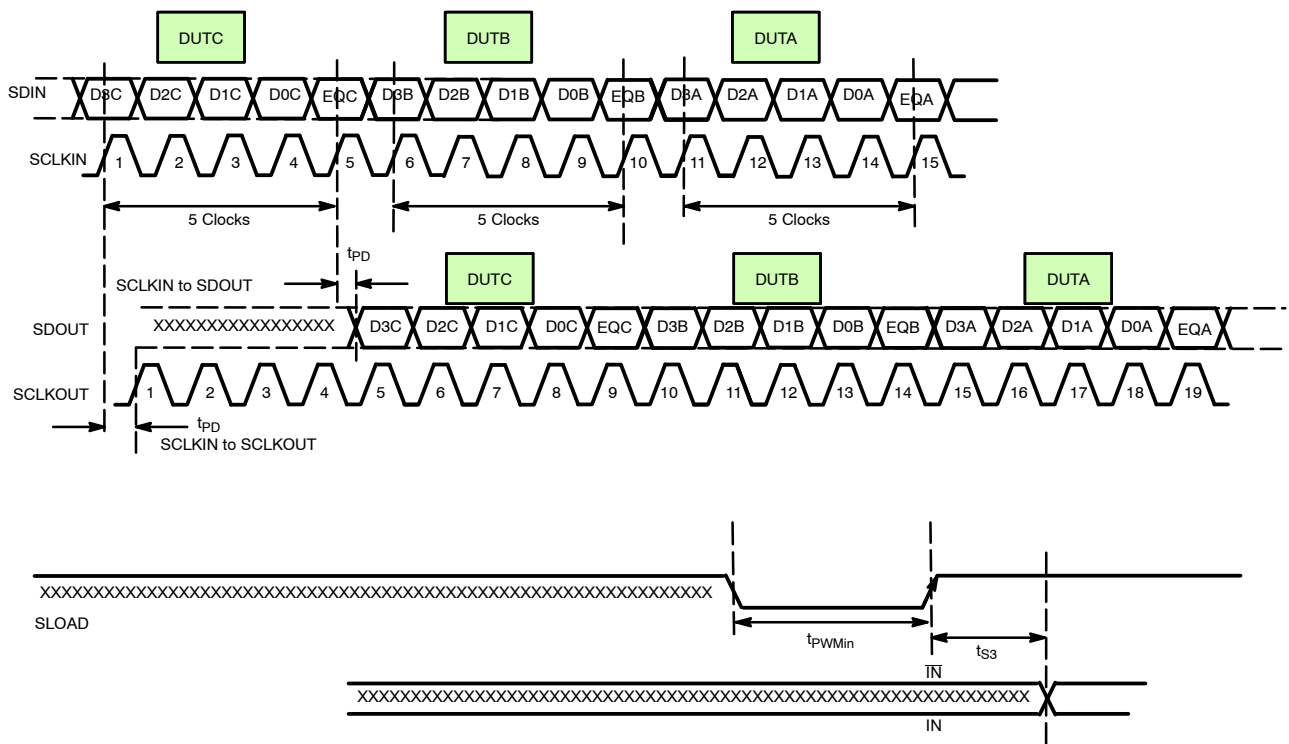
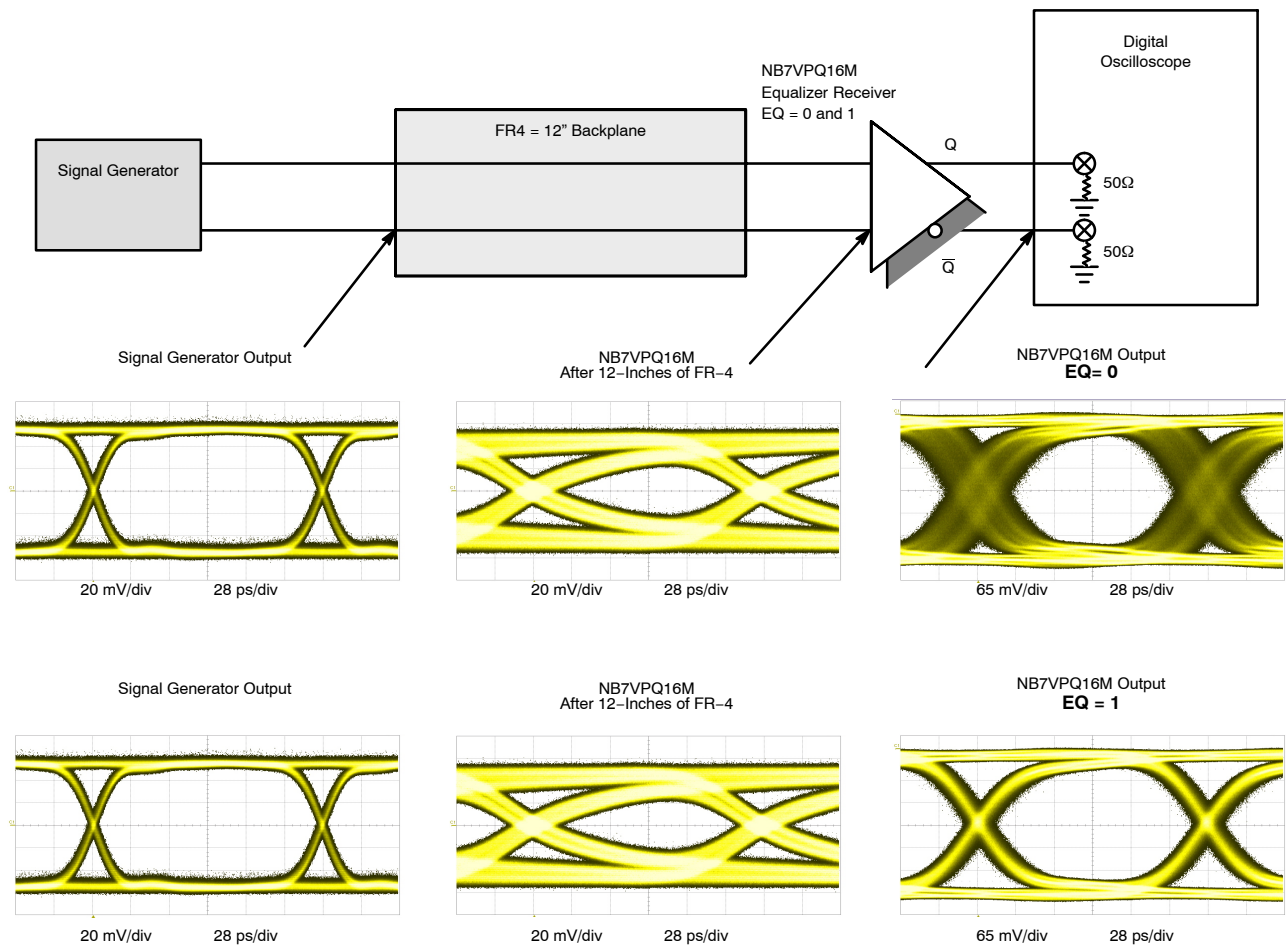


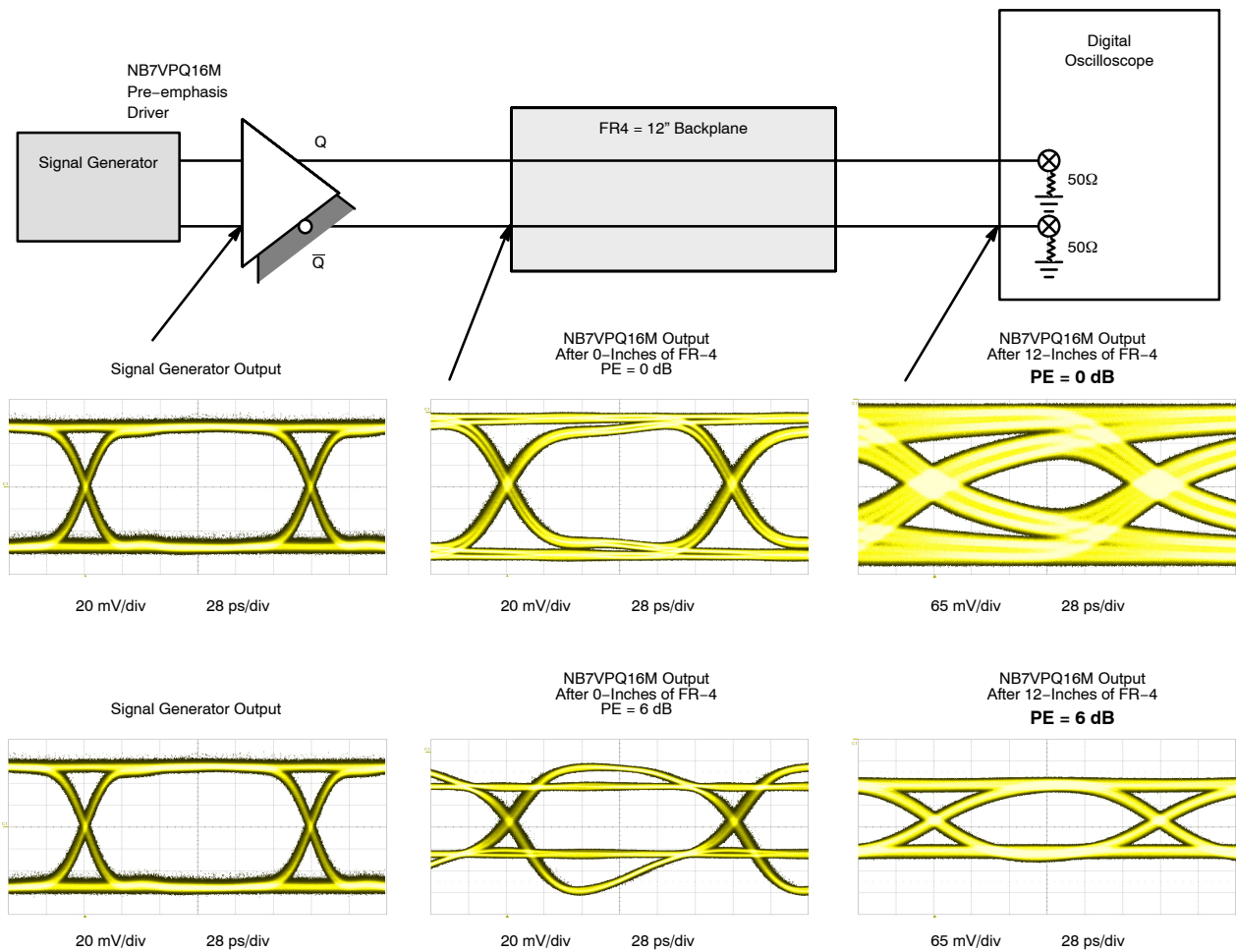
Figure 14. Simplified Cascaded Serial Data/Clock Timing Diagram

# NB7VPQ16M



**Figure 15. Typical NB7VPQ16M Equalizer Application and Interconnect; Eye Diagrams with PRBS23 Pattern at 6 Gbps**

# NB7VPQ16M



**Figure 16. Typical NB7VPQ16M Pre-Emphasis Application Interconnect; Eye Diagrams with PRBS23 Pattern at 6 Gbps Without and With Pre-Emphasis**

## NB7VPQ16M

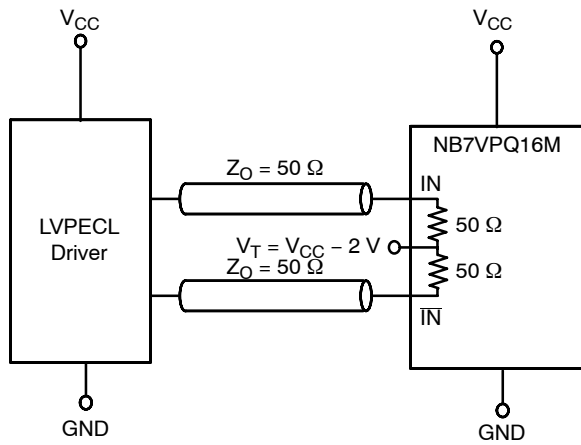


Figure 17. LVPECL Interface

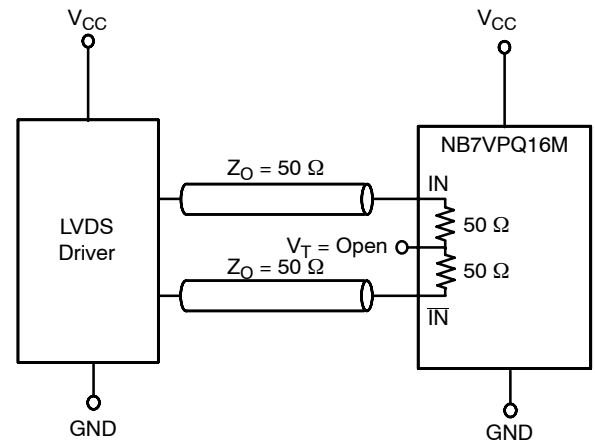


Figure 18. LVDS Interface

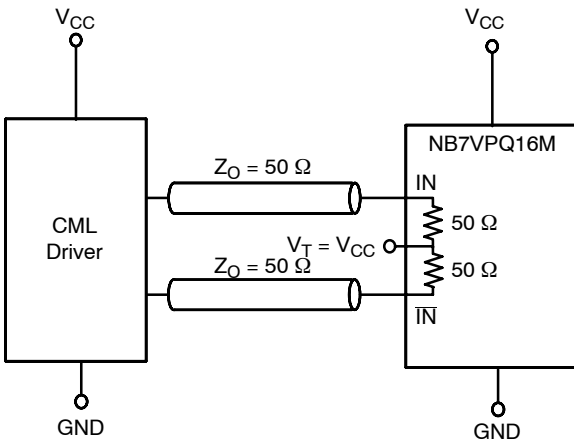


Figure 19. Standard 50 Ω Load CML Interface

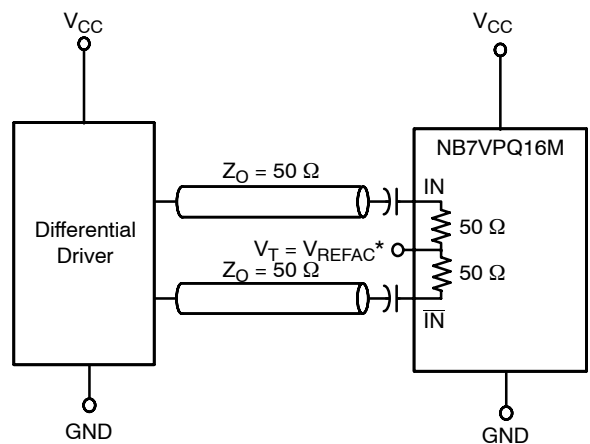


Figure 20. Capacitor-Coupled  
Differential Interface  
(V<sub>T</sub> Connected to External V<sub>REFAC</sub>)

\*V<sub>REFAC</sub> bypassed to ground with a 0.01 μF capacitor

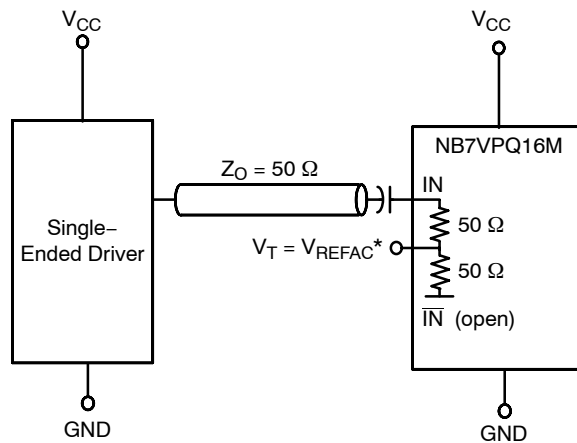


Figure 21. Capacitor-Coupled  
Single-Ended Interface  
(V<sub>T</sub> Connected to External V<sub>REFAC</sub>)

## NB7VPQ16M

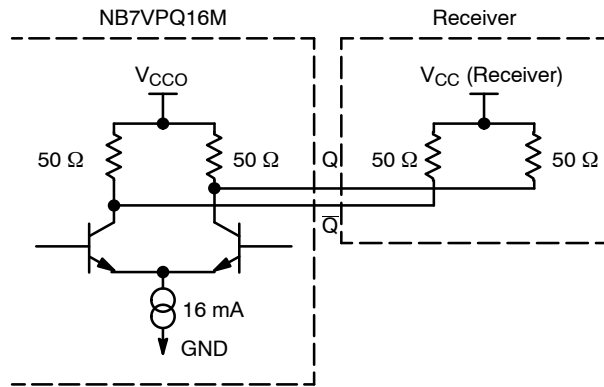


Figure 22. Typical CML Output Structure and Termination

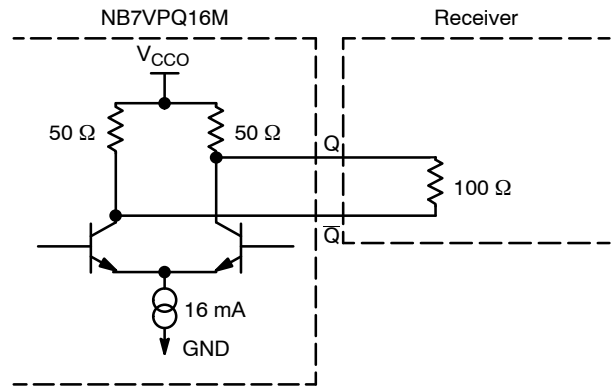


Figure 23. Alternative Output Termination

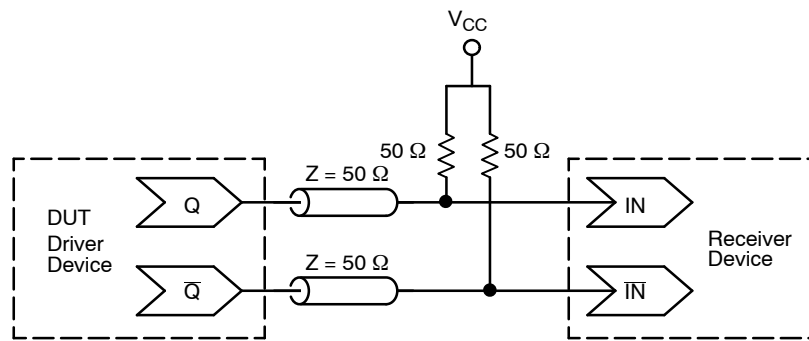


Figure 24. Typical Termination for CML Output Driver and Device Evaluation

### ORDERING INFORMATION

Device	Package	Shipping
NB7VPQ16MMNG	QFN-16 (Pb-free)	123 Units / Tube

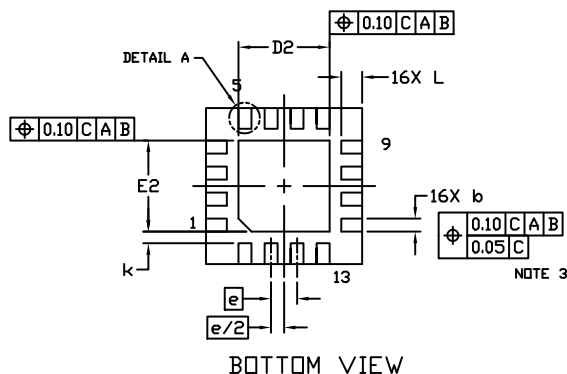
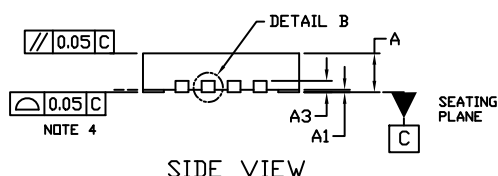
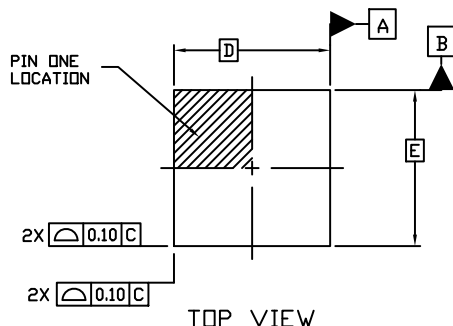
# MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



SCALE 2:1

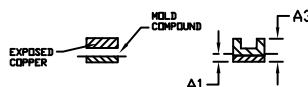
## QFN16 3x3, 0.5P CASE 485G ISSUE G

DATE 08 OCT 2021

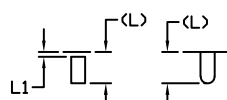


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.



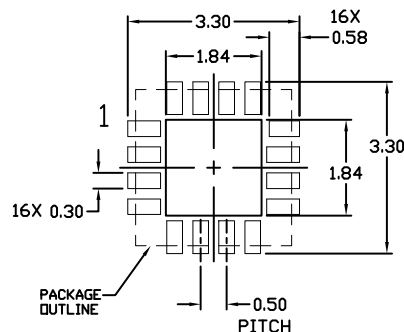
DETAIL B  
ALTERNATE  
CONSTRUCTIONS



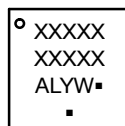
DETAIL A  
ALTERNATE TERMINAL  
CONSTRUCTIONS

DIM	MILLIMETERS		
	MIN.	NDM.	MAX.
A	0.80	0.90	1.00
A1	0.00	0.03	0.05
A3	0.20 REF		
b	0.18	0.24	0.30
D	3.00 BSC		
D2	1.65	1.75	1.85
E	3.00 BSC		
E2	1.65	1.75	1.85
e	0.50 BSC		
k	0.18 TYP		
L	0.30	0.40	0.50
L1	0.00	0.08	0.15

### MOUNTING FOOTPRINT



### GENERIC MARKING DIAGRAM\*



XXXXX = Specific Device Code  
A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	QFN16 3X3, 0.5P	PAGE 1 OF 1

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